



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Jae Hak Yee et al.	)	Confirmation No.	7012
		)		
Serial No.:	10/667,227	)	Art Unit:	2822
		)		
Filed:	09/18/2003	)	Examiner:	Rose, Kiesha L.
		)		
For:	Semiconductor Package and Method	)		
	of Making Leadframe Having Lead	)		
	Locks to Secure Leads to	)		
	Encapsulant	)		

**AMENDMENT UNDER 37 C.F.R. §1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir/Madam:

Responsive to the Office Action of September 16, 2004, the period for response extending until December 16, 2004, reconsideration of this action and allowance of all the claims of the present invention are respectfully requested in view of the following Amendments and Remarks:

*Amendments to the Claims* begin on page 2 of this paper;

*Amendments to the Drawings* begin on page 5 of this paper;

*Remarks* begin on page 6 of this paper; and

an **APPENDIX** [including a copy the Supplemental Preliminary Amendment filed on October 6, 2003 (pages 1-6)] is additionally attached to this paper.